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FCH023N65S3 N-Channel SuperFET[®] III MOSFET 650 V, 75 A, 23 mΩ

Features

- 700 V @ T_J = 150°C
- Typ. R_{DS(on)} = 19.5 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 222 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 1980 pF)
- 100% Avalanche Tested
- RoHS Compliant

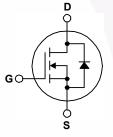
Applications

- Telecom / Server Power Supplies
 UPS / Solar
- Industrial Power Supply

Description

SuperFET[®] III MOSFET is Fairchild Semiconductor's brandnew high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SuperFET III MOSFET is suitable for various DC/AC power conversion for system miniaturization and higher efficiency.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCH023N65S3_F155	Unit			
V _{DSS}	Drain to Source Voltage	650	V			
V _{GSS}	Cata ta Source Maltage	- DC		±30	V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		75	A	
		- Continuous (T _C = 100°C)		65.8		
I _{DM}	Drain Current	- Pulsed	(Note 1)	300	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			2025	mJ	
I _{AR}	Avalanche Current (Note			15	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)			5.95	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P _D	Dower Dissinction	(T _C = 25°C)		595	W	
	Power Dissipation	- Derate Above 25°C		4.76	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
Τ _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCH023N65S3_F155	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	0/11

June 2016

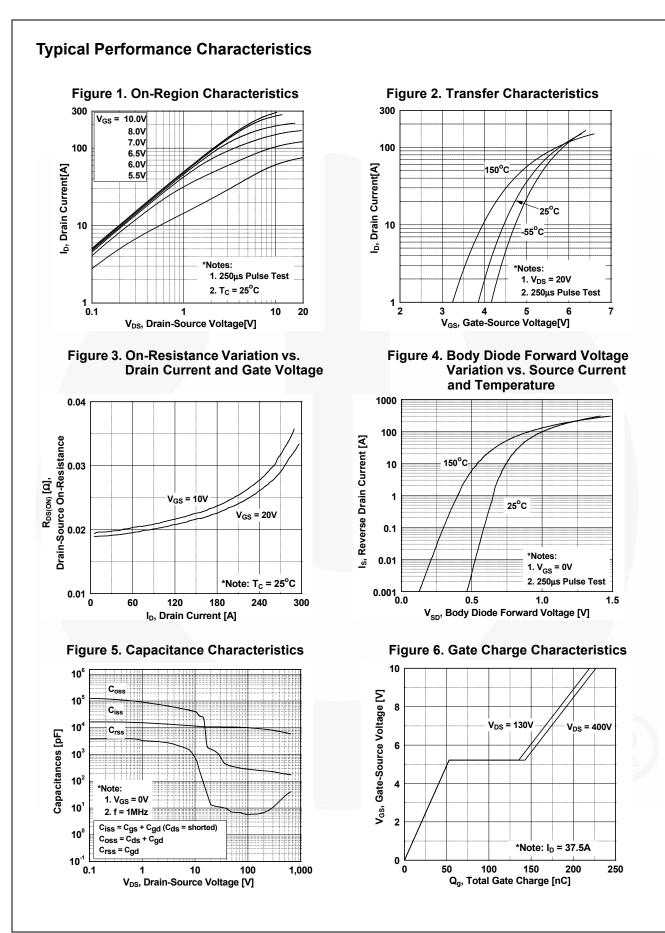
Part Nu	mber	Top Mark	Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity
FCH023N65	FCH023N65S3_F155 FCH023N65S3		TO-247 G03	Tube	N/A	N/A		30 units	
Electrica	l Chara	acteristics T _C	= 25 ^o C unless o	therwise noted.		·			
Symbol	Parameter			Test Conditions			Тур.	Max.	Unit
Off Charad	teristics	5							
	Drain to Source Breakdown Voltage			V _{GS} = 0 V, I _D = 1 mA,	T⊥= 25°C	650	-	-	T
BV _{DSS}				$V_{GS} = 0 V, I_D = 1 mA, T_J = 150^{\circ}C$		700	-	-	V
ΔBV_{DSS}	Breakdo	wn Voltage Tempera	ture	$I_D = 1$ mA, Referenced to 25°C		-	0.72	_	V/ºC
$/\Delta T_{J}$	Coefficient					-	0.72		V/ C
I _{DSS}	Zero Ga	te Voltage Drain Current		V _{DS} = 650 V, V _{GS} = 0 V		-	-	1	μA
				$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 128$		-	6.8	-	
I _{GSS}	Gate to Body Leakage Current $V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$		V	-	-	±100	nA		
On Charac	teristics	j							
V _{GS(th)}	Gate Th	reshold Voltage		V _{GS} = V _{DS} , I _D = 7.5 m	A	2.5	-	4.5	V
R _{DS(on)}	Static Dr	ain to Source On Re	sistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 37.5$		-	19.5	23	mΩ
9 _{FS}	Forward Transconductance			V _{DS} = 20 V, I _D = 37.5 A			66	-	S
C _{iss}	Characteristics Input Capacitance			$V_{\rm DS} = 400 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V},$		-	7160	-	pF
C _{oss}	Output Capacitance			f = 1 MHz		-	195	-	pF
C _{oss(eff.)}	Effective Output Capacitance $V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$			1980	-	pF			
C _{oss(er.)}	0,	Related Output Capa	citance	$V_{DS} = 0 V$ to 400 V, V		-	298	-	
Q _{g(tot)}		te Charge at 10V		V _{DS} = 400 V, I _D = 37.5 A, V _{GS} = 10 V (Note 4)			222 54	-	nC
Q _{gs}		Source Gate Charge Drain "Miller" Charge				-	90	-	nC nC
Q _{gd} ESR		nt Series Resistance		f = 1 MHz	(1000-1)	-	0.9	-	Ω
LOR	Equivale		;			-	0.9	-	52
Switching	Charact	eristics							
t _{d(on)}	Turn-On	Delay Time				-	45	-	ns
t _r	Turn-On	Rise Time		V_{DD} = 400 V, I _D = 37.5 A, V_{GS} = 10 V, R _g = 2 Ω		-	55	-	ns
t _{d(off)}		Delay Time				-	140	-	ns
t _f	Turn-Off	Fall Time		(Note 4)			29	-	ns
Drain-Sou	rce Diod	e Characteristic	cs						
I _S	Maximum Continuous Drain to Source Diode Forward Current			_	-	75	Α		
I _{SM}		n Pulsed Drain to So				-	-	300	Α
V _{SD}	Drain to	Source Diode Forwa	rd Voltage	V _{GS} = 0 V, I _{SD} = 37.5	A	-	-	1.2	V
		Recovery Time	-	$V_{GS} = 0 V, I_{SD} = 37.5 A,$ $dI_F/dt = 100 A/\mu s$		-	600	-	ns
t _{rr}	Reverse	Recovery fille							

1. Repetitive rating: pulse width limited by maximum junction temperature.

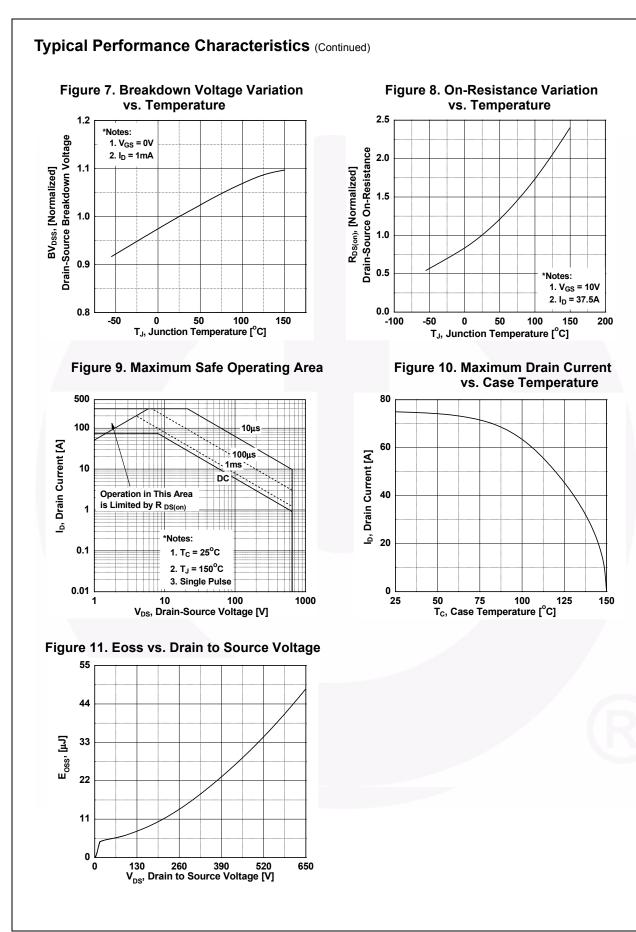
2. I_{AS} = 15 A, R_G = 25 Ω , starting T_J = 25°C.

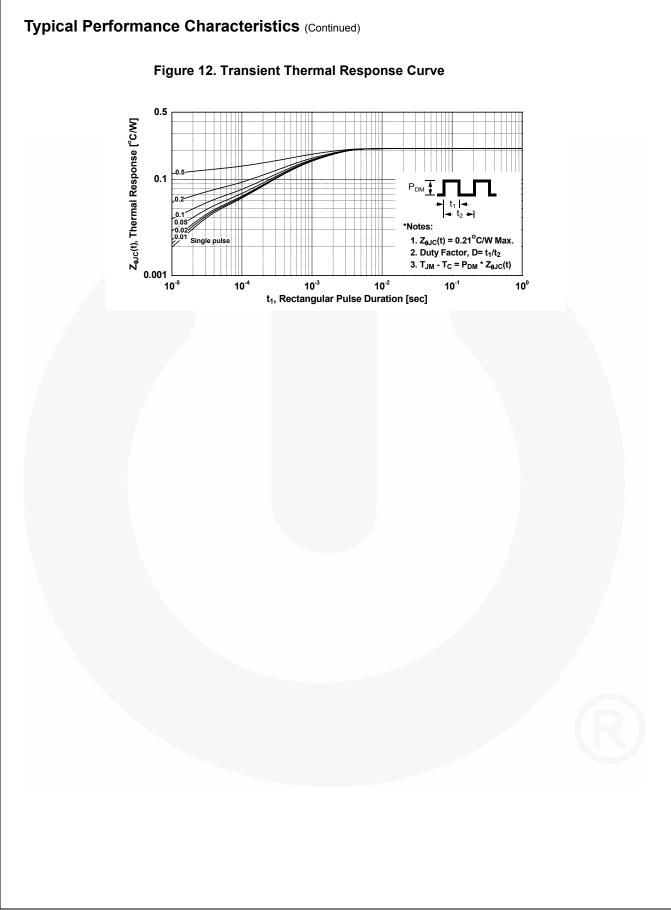
3. I_{SD} \leq 75 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25°C.

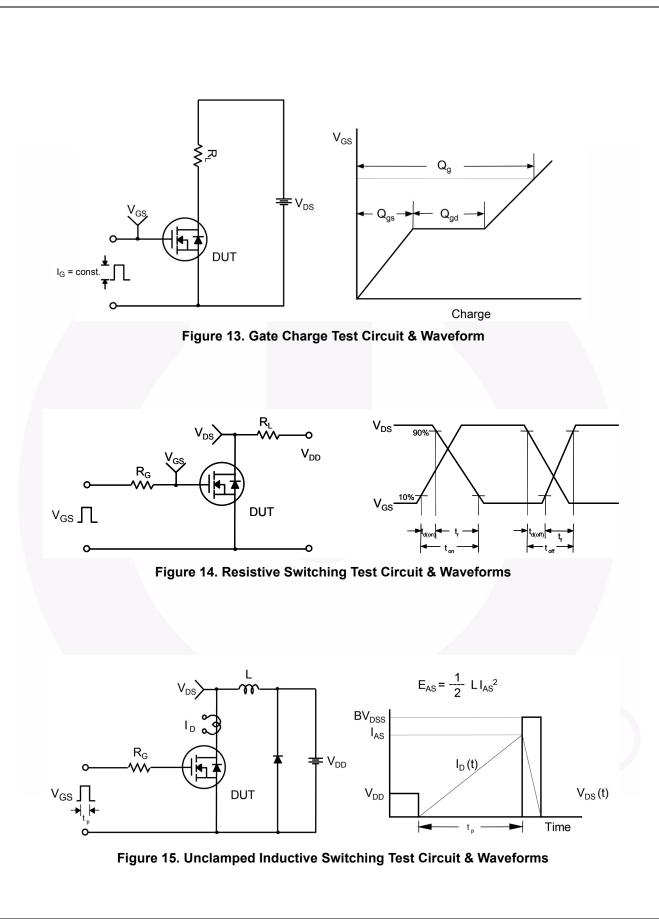
4. Essentially independent of operating temperature typical characteristics.

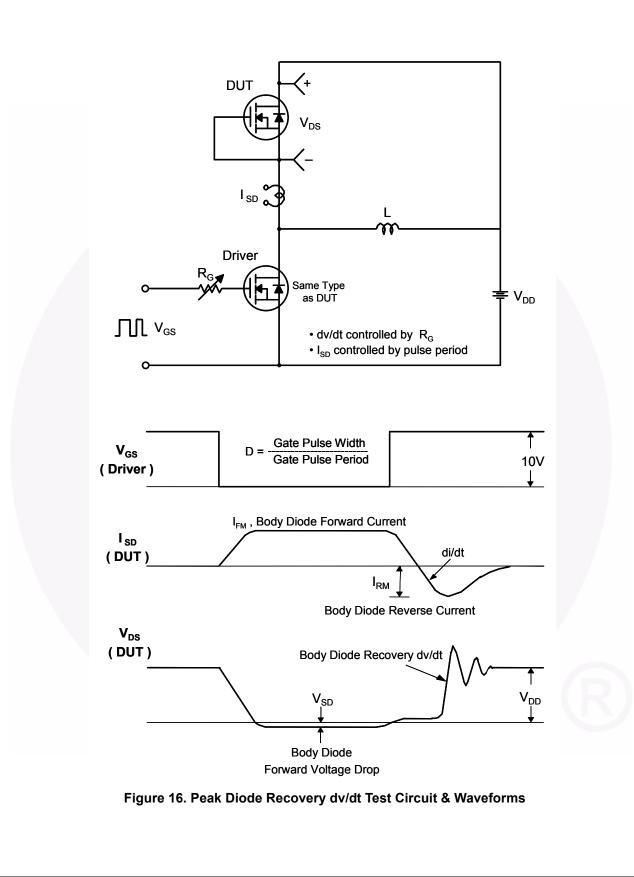


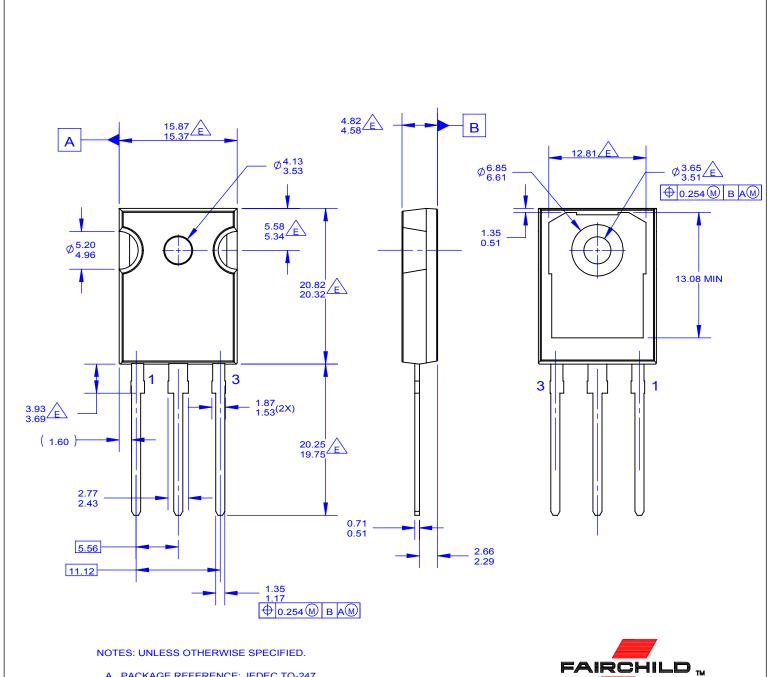
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